

Blu Intraoral Sensor Technical Info



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DESCRIPTION AND INTENDED USE

Bluis a digital imaging solution for Intra oral dental radiography based on CMOS (Complementary Metal-oxide Semiconductor) technology. The sensor is a receptor which captures the images obtained when using an X-Ray generator for diagnostic purposes. State-of-the-art technology reduces the patients'exposure and provides excellent image quality with no missing data due to the single-chip CMOS.

The head has an ergonomic design based on human oral anatomy for patient convenience and comfort.

Blu employs a fibre optic plate with CSI scintillator for X-Ray-to-light converter. The FOP(Fiber Optic Plate) is a highly X-Ray attenuatin g material that minimizes X-Ray absorption on the end CMOS photosensor array, thus minimizing X-Ray induced noise at the photosensor array. In addition, the scintillators offer high-resolution performance compared to conventional phosphors.

Blu outputs X-Ray imaging data output of CM OS to 12-bit Digital Data through ADC. In addition, it can detect the external X-Ray source and send a trigger signal to acquire the synchronized X-Ray Imaging Data.

Blu is available in two sizes:

Blu size 1 20.00 x 30.01 mm active area **Blu size 2** 25.95 x 37.96 mm active area

Code ISO14-S Blu intraoral sensor size 1 Code ISO15-S Blu intraoral sensor size 2

Key Features

Rounded off edges

Smooth casing

Outstanding cable flexibility,

Direct connection to personal computer for imageuisition via USB direct connector.

Cesium Iodide (CsI) scintillator layer Available in two formats: size 1 and size 2

GENERAL CHARACTERISTICS		
Unit name	Blu	
Manufacturer	Trident Srl Via Artigiani 4, Castenedolo, 25014 (BS) Italy	
Classification according to Directive EC 93/42	Class IIa with Type BF applied parts	
Applicable Standards	EN 60601-1:2005 EN 60601-1-2:2007 IEC 60601-2-65:2012	





SPECIFICATIONS					
Parameter	Unit	Size 1	Size 2		
Sensor Type	-	CMOS Photodiode Array			
X-ray convertor	-	FOS(FOP + Csl)			
Dimensions W x L x H)	mm	25.4 x 36.8 x 4,8	31,3 x 42,9 x 4,8		
Weight	gr	Less than 100			
Pixel Size	μm	18			
Active Area	mm	20,00 x 30,01	25,95 x 37,96		
Effective Area*	mm	19,80 x 29,80	25,77 x 37,78		
Number of Active Pixels	pixels	1110 x 1666	1442 x 1998		
Number of Effective Pixels	pixels	1100 x 1656	1432 x 1988		
Data output	-	USB 2.0			
USB cable length	m	Less than 2.7			
Electrical rating		DC 5V, 500 mA			
Operation mode		Global shutter			
Protection against water		IP68			

^{*} X-Ray sensitive area

RECOMMENDED OPERATING CONDITIONS				
Parameter	Unit	Specification		
Operating temperature	°C	+10 to +30		
Operating humidity	%	30 to 80		
Storage temperature	°C	-20 to +60		
Storage humidity	%	10 to 80		

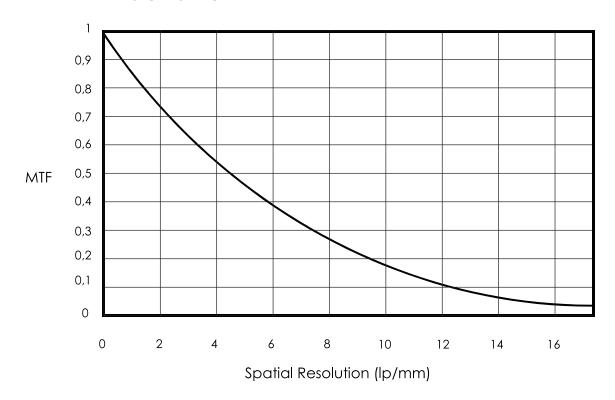
SENSOR PERFORMANCE SPECIFICATIONS				
Parameter	Unit	Size 1	Size 2	
SNR	dB	≥ 35	≥ 35	
Sensitivity ¹	ADU/µGy ²	5,0 to 8,0	5,0 to 8,0	
Resolution ³	3lp/mm	≥ 50	≥ 50	
	6lp/mm	≥ 25	≥ 25	
	8lp/mm	≥ 15	≥ 15	
Noise ⁴	ADU	≤ 2,0	≤ 2,0	
A/D	Bits	12	12	
Energy Range 5	kVp	60 ~ 70	60 ~ 70	

- 1 Measured @ 60 kVp, 4mm Al filter
- 2 μGy is the unit of X-Ray exposure (1mR = 8.69 μGy)
- 3 Theoretical Spatial Resolution
- 4 RMS of dark current
- 5 Recommended Range, more than 70 kVp affects the sensor's life time





RESOLUTION



SYSTEM REQUIREMENTS

- 1. Operating System
 - Windows® 7 (32/64 bit) SP1, Windows® 8 64 bit, Windows® 10
- 2. Hardware requirements:
 - Main CPU: Intel i5-2520M 2.5 GHz or superior
 - Main Memory: 4 GB
 - Video: 1024x768 resolution in 65,000 colours (idedly 1280x1024 16 million colours, 32 bit)
 - HDD: 500 GB
 - USB Port 2.0





GEOMETRIC INFORMATION (in mm)

Sensor head



Interface board Interface board is common component for both sizes









PACKAGING			
Box	W (Kg)	Size (cm)	
	0.4Kg	18 x 13 x h3.5	

